EEE 131 Key concepts and Equations

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1 Diode Models and Circuits

1.1 History of Electronics

- 1. 1904: John Fleming invented vacuum tubes. First time electron flow is controlled in non-conducting medium
 - (a) if the cathode is heated, some electrons can escape
 - (b) if a voltage is applied (+) on anode (-) on cathode, there will be current
- 2. 1906: the grid was added to control the current between the anode and cathode
 - (a) vacuum tubes allowed the development of amplifiers, transmitters, receivers, signal processor
- 3. 1946: the ENIAC computer was completed. it could execute 5000 additions per second
- 4. 1947: invention of transistor by Shockley, Bardeen, Brattain at the Bell Labs
 - (a) they were point-contact transistors
- 5. 1948: Schockley invented the BJT. the BJT is monolithic (containted in a single semiconductor crystal)
- 6. 1958: the first Integrated Circuits (IC) was invented by Jack Kilby of Texas Instruments (non-monolithic)
- 7. 1959: the first monolithic IC was developed by Robert Noyce at Fairchild Semiconduction
 - (a) uses silicon instead of germanium
 - (b) 2 interconnected BJT transistor
 - (c) SiO_2 insulator, Al interconnection
 - (d) planar IC, 0.06 in diameter
- 8. Bipolar ICs with BJT devices domidated until early 80s
 - (a) S/M/L Scale Integration: 10, 100, 1000 transistors
- 9. 1959: MOS ICs started in the 60s after the MOS transistor was develooed at Bell Labs
 - (a) easier to fabricate than bipolar
 - (b) uses less power
 - (c) can fit more transistor in the same silicon area
 - (d) slower than bipolar IC
 - (e) less robust than bipolar IC

- 10. MOS ICs
 - (a) early 70s: MOS technology improved in speed and reliability
 - (b) first microprocessor: Intel 4004 (1971)
 - (c) emergence of VLSI (>10000 trasistors)
 - (d) microprocessors evolved into microcontrollers (MCUs) ad system on a chip (SOCs)
- 11. Moore's Law: the transistor density would double every two years

1.2 Piecewise Linear Diode Models

- 1. 1st Approximation: (when $v_s \gg V_T$)
 - (a) Open when $v_D < 0$
 - (b) Short when $v_D \geq 0$
- 2. 2nd Approximation (when above condition not satisfied):
 - (a) Open when $v_D < V_T$
 - (b) Voltage of V_T when $v_D \geq V_T$
- 3. 3rd Approximation (2nd with resistor R in series)
 - (a) Open when $v_D < V_T$
 - (b) Voltage of V_T in series with resistance R when $v_D \ge V_T$
- 4. To determine diode state:
 - (a) Assume it is conducting
 - (b) Check direction of current
 - (c) If current is from anode to cathode, the assumption is correct and equivalent circuit is valid
 - (d) Otherwise, diode should be open
- 5. Another method:
 - (a) Replace diode with open circuit
 - (b) Determine the voltage across the diode terminals (+) on anode, (-) on cathode
 - (c) If v_D < the needed threshold, assumption is correct
 - (d) Otherwise, diode should be replaced with the appropriate model

1.3 Practical Diode Circuits

1. Half Wave Rectifier

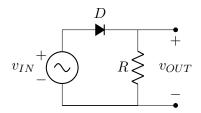


Figure 1: Half Wave Rectifier

(a) When diode is IDEAL:

$$v_{OUT} = \begin{cases} 0, & v_{IN} < 0 \\ v_{IN} & v_{IN} \ge 0 \end{cases}$$

(b) When diode has constant voltage model:

$$v_{OUT} = \begin{cases} 0, & v_{IN} < V_T \\ v_{IN} - V_T & v_{IN} \ge V_T \end{cases}$$

2. Full Wave Rectifier ($v_1 = v_2$)

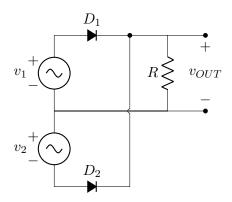


Figure 2: Full Wave Rectifier

(a) When diode is IDEAL:

$$v_{OUT} = |v_{IN}|$$

(b) When diode has constant voltage model:

$$v_{OUT} = \left\{ egin{array}{ll} v_1 - V_T, & v_1 > V_T \\ -v_2 - V_T, & v_2 < -V_T \\ 0 & ext{otherwise} \end{array}
ight.$$

(c) This requires a transformer with center-tapped secondary ($n_1:n_2=1:2$)

3. Full Wave Bridge Rectifier

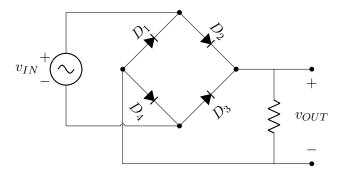


Figure 3: Full Wave Bridge Rectifier

(a) When diode is IDEAL:

$$v_{OUT} = |v_{IN}|$$

(b) When diode has constant voltage model:

$$v_{OUT} = \left\{ egin{array}{ll} v_1 - 2V_T, & v_1 > 2V_T \\ -v_2 - 2V_T, & v_2 < -2V_T \\ 0 & ext{otherwise} \end{array}
ight.$$

4. Positive Clipper

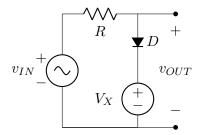


Figure 4: Positive Clipper

(a)
$$v_{OUT} = \left\{ egin{array}{ll} V_X + V_T, & v_{IN} - V_X > V_T \\ v_{IN}, & v_{IN} - V_X < V_T \end{array} \right.$$

5. Negative Clipper

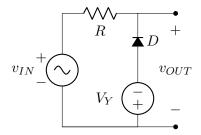


Figure 5: Negative Clipper

(a)
$$v_{OUT} = \begin{cases} -(V_Y + V_T), & -V_Y - v_{IN} > V_T \\ v_{IN}, & -V_Y - v_{IN} < V_T \end{cases}$$

6. The positive and negative clippers can be combined

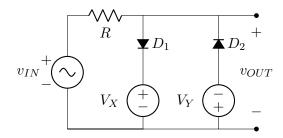


Figure 6: Positive and Negative Clipper

(a)
$$v_{OUT}=\left\{egin{array}{ll} V_X+V_T,&v_{IN}-V_X>V_T\\ &-\left(V_Y+V_T
ight),&-V_Y-v_{IN}>V_T\\ &v_{IN},& ext{otherwise} \end{array}
ight.$$

7. Peak Detector

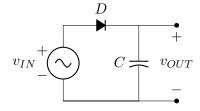


Figure 7: Peak Detector

- (a) Let the time t_1 be the first time the input reaches its maximum value V_P and t_0 be the time to reach V_T
- (b) When diode is IDEAL

$$v_{OUT} = \begin{cases} v_{IN}, & t < t_1 \\ V_P, & t \ge t_1 \end{cases}$$

(c) When diode has constant voltage model:

$$v_{OUT} = \begin{cases} 0, & 0 \le t < t_0 \\ v_{IN} - V_T, & t_0 \le t < t_1 \end{cases}$$
$$V_P - V_T \quad t_1 \le t$$

8. Peak Detector with Load Resistor (Ideal Diode)

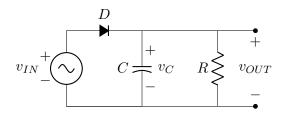


Figure 8: Peak Detector with load resistor

(a) Let the time t_1 be the first time the input reaches its maximum value V_P and the period be T. When the capacitor voltage decays, let time t_2 be when $v_C = v_{IN}$ again

$$\text{(b) } v_{OUT} = \left\{ \begin{array}{ll} v_{IN}, & t < t_1 \\ V_P \exp\left(-\frac{t-t_1}{RC}\right), & t_1 \leq t < t_2 \\ \\ v_{IN}, & t_2 \leq t < t_1 + T \\ \\ V_P \exp\left(-\frac{t-(t_1+T)}{RC}\right), & t_1 + T \leq t < t_2 + T \\ \\ \vdots & \vdots \end{array} \right.$$

9. Negative Clamper (ideal diode)

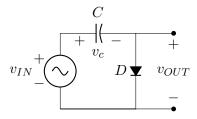


Figure 9: Negative Clamper

- (a) Let the time t_1 be the first time the input reaches its maximum value \mathcal{V}_P
- (b) This is similar to the peak detector, only that $v_{OUT}=v_{IN}-v_C$ where v_C follows the characteristic of the peak detector

(c)
$$v_C = \left\{ egin{array}{ll} v_{IN}, & t < t_1 \\ V_P, & t_1 \leq t \end{array} \right.$$

(d)
$$v_{OUT} = \left\{ egin{array}{ll} 0, & t < t_1 \\ \\ v_{IN} - V_P, & t \geq t_1 \end{array} \right.$$

10. Positive Clamper (ideal diode)

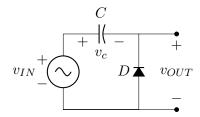


Figure 10: Positive Clamper

(a) Let the period be T

(b)
$$v_C = \begin{cases} 0, & 0 \le t < T/2 \\ v_{IN}, & T/2 \le t < 3T/4 \\ -V_P, & 3T/4 \le t \end{cases}$$

(c)
$$v_{OUT} = \begin{cases} v_{IN}, & 0 \le t < T/2 \\ 0, & T/2 \le t < 3T/4 \\ v_{IN} + V_P, & 3T/4 \le t \end{cases}$$

1.4 Exponential Diode Model

1. Shockley's Diode Equation

$$i_D = I_S \left[\exp\left(\frac{v_D}{\eta V_T}\right) - 1 \right]$$
 (1)

- (a) v_D : diode voltage with positive at anode
- (b) i_D : diode current from anode to cathode
- (c) I_S : reverse saturation current due to minority carriers. $10^{-15} {\rm A} < I_s < 10^{-9} {\rm A}$
- (d) η : ideality factor, $1 < \eta < 2$; close to 1 for well fabricated diodes
- (e) V_T : thermal voltage, $V_T = \frac{kT_K}{e} \approx \frac{T_K}{11600}$
- 2. for typical operating voltages (forward biased): $\exp\left(\frac{v_D}{\eta V_T}\right)\gg 1 \implies i_D\approx I_S\exp\left(\frac{v_D}{\eta V_T}\right)$
- 3. for typical reverse bias voltages, $\exp\left(\frac{v_D}{\eta V_T}\right) \ll 1 \implies i_D \approx -I_S$

1.5 Small Signal Model

- 1. $v_D = V_D + v_d$
- 2. $i_D = I_D + i_d$. I_D is calculated using large signal analysis
- 3. if the amplitude of v_d is very small, the diode characteristic equation is approximately a line with conductance $g_d = \frac{\partial i_D}{\partial v_D} = \frac{I_S}{\eta V_T} \exp\left(\frac{v_D}{\eta V_T}\right) \approx \frac{I_D}{\eta V_T} \implies r_d = \frac{\eta V_T}{I_D}$

1.6 Zener Diode



1. has 3 modes of operations:

Operation	Condition	Equivalent
Forward-biased	$v_D \le V_T$	$v_D = -V_T$
Non-conducting	$-V_T < v_D < V_Z$	open circuit
Zener region	$v_D \ge V_Z$	$v_D = V_Z$

2 PN Juncion and BJT Operation

2.1 Semiconductor Fundamentals

- 1. The Silicon (14) Atom:
 - (a) has 4 valence electrons
 - (b) the semiconductor lattice has bounded valence electrons at 0K
 - (c) energy bands: electrons can occupy discrete energy levels
 - (d) there is a **band gap** between the valence band and conduction band
 - (e) at higher temperatures, an electron can gain enough energy to break the bonds
 - (f) when an electron leaves a bond, it leaves a positively charged hole
- 2. Groups by electrical properties:
 - (a) insulators: huge band gap
 - (b) conductor: conduction band and valence overlap
 - (c) semiconductor: small band gap that can be easily reached
- 3. Semiconductors:
 - (a) narrow band gap
 - (b) has 2 groups:
 - i. intrinsic: just enough valence electrons to complete the matrix. either has group IV semi-conductors (Si and Ge) or III-V compound (GaAs)
 - ii. extrinsic: produced by doping intrinsic semiconductors
 - A. N-type: dopants have excess electrons. energy level just below the conduction band
 - B. P-type: dopants have less electrons. energy level just above the valence
- 4. Fermi level: hypothetical energy level where there is 50% probability that the level is occuppied by an electron at any given time
 - (a) intrinsic semiconductor: midway between E_C and E_V
 - (b) extrinsic semiconductor:
 - i. N-type: closer to E_C
 - ii. P-type: closer to E_V

2.2 Carrier Actions in Semiconductors

- 1. Charge Carriers: the electrons and holes. units in coulombs (C)
- 2. Intrinsic semiconductor: n = p equal concentration of electrons and holes
- 3. N-type semiconductors:
 - (a) n > p
 - (b) majority charge carriers: electrons
 - (c) minority charge carriers: holes
- 4. P-type semiconductors:
 - (a) p > n

- (b) majority charge carriers: holes
- (c) minority charge carriers: electrons
- 5. Current: rate of movement of charge past a point or region. units in ampere (A). + is the direction of the hole/opposite the electron
- 6. Mobility: ability of charge carrier to move. $\mu_e > \mu_h$
- 7. Factors that affect mobility:
 - (a) Scattering the random motion of charges. One mechanism is the *lattice scattering* when electrons bump with the vibrating lattice or other electrons and change directions
 - (b) another scattering mechanism is *impurity scattering* when dopant ions deflect charge carriers
 - (c) Temperature vs Scattering vs Mobility. At low temperatures, impurity scattering dominates (and with low mobility). at high temperatures, lattice scattering dominates (and low mobility). there is a temperature in the middle with maximum mobility. (like a parabolic log-log graph)
 - (d) Doping vs Scattering vs Mobility. more doping = more impurity scattering
 - (e) scattering has a net current of 0
- 8. There are 3 primary carrier actions:
 - (a) Generation and Recombination: generation = electron gains enough energy to break a covalent bond and leaves a hole. recombination = moving electron moves close to a hole and experience attractive force
 - (b) Diffusion: electrons move from higher concentration/temperature to lower concentration/temperature. + diffusion is parallel to positive charges. becomes 0 when there is uniform distribution of charge carriers
 - (c) Drift: caused by applied external voltage. modeled by a constant drift velocity $v_d = \mu E$ (directly related to the electric field with the mobility as constant)
 - i. $I_n = -Aqnv_{\text{n-drift}}$
 - ii. $I_p = Aqpv_{p-drift}$

2.2.1 PN Junction

- 1. PN Junction: formed when in a single silicon crystal, one region is doped with donor dopants (N-type) and the other with acceptor dopants (P-type). PN Junction is the boundary.
- 2. Depletion Region: happens at the boundary when the electrons diffuse and recombine with the holes at the P-type region. This results to a potential difference (and thus an electric field) across the depletion region (points from N to P)
 - (a) drift current of minority carriers are drifted by this electric field
- 3. There are 3 junction operations:
 - (a) Open-circuit (equilibrium condition):
 - i. the diffusion current I_D is limited by the built in voltage V_0 and equal to the drift current I_S
 - (b) Forward Bias (+ on the P-type)
 - i. the + potential pushes the holes in the P-type and the depletion region in the P-side decreases

- ii. the potential pushes the electrons in the N-type and the depletion region in this side also decreases
- iii. the diffusion current I_D dominates, but the temperature dependent I_S remain the same
- iv. the net current $I = I_D I_S$ in the direction from P to N
- v. when $V_F \geq V_o$, the depletion region disappears and $I \approx I_D$
- (c) Reverse Bias (+ on the N-type)
 - i. the + potential attracts the electrons in the N-type, the depletion region becomes larger
 - ii. the potential attracts the holes in the P-type, the depletion region becomes larger
 - iii. the voltage V_o increases so I_D decreases
 - iv. net current $I = I_D I_S$ from N to P
 - v. if I_D becomes very small, $I \approx -I_S$
- 4. The energy band diagram will align the Fermi levels, thus bending the E_C and E_V with the maximum deviation V_0
 - (a) at forward bias, V_0 decreases so the bending energy will also decrease and the Fermi level will not be aligned anymore (E_{FN} is higher)
 - (b) at reverse bias, V_0 increases so the bending energy will also increase and the Fermi level will not be aligned anymore (E_{FN} is lower)
- 5. The PN Junction implements a Diode. anode at P, cathode at N
 - (a) the Shockley Equation summarizes the 3 conditions for the PN Junction operations
 - (b) Diode resistivity:
 - i. at higher temperature, more electrons are freed and resistivity decreases
 - ii. higher doping density lowers the resistivity

3 BJTs as Amplifiers

3.1 DC Characteristics and Operating Modes

Mode of Operation	EB Junction	CB Junction
Cut-off	Reverse-biased	Reverse-biased
Active	Forward-biased	Reverse-biased
Saturation	Forward-biased	Forward-biased
Reverse Active	Forward-biased	Reverse-biased

1. Cutoff Mode Relationships:

(a)
$$I_B = I_C = I_E = 0$$

2. Active Mode Relationships:

(a)
$$I_B = \frac{I_S}{\beta} \left[\exp\left(\frac{eV_{BE}}{kT}\right) - 1 \right] \left[1 + \frac{V_{CE}}{V_A} \right]$$

(b)
$$I_C = \beta I_B = I_S \left[\exp\left(\frac{eV_{BE}}{kT}\right) - 1 \right] \left[1 + \frac{V_{CE}}{V_A} \right]$$

(c)
$$I_E = \frac{1}{\alpha} I_C = (\beta + 1) I_B$$

(d)
$$\alpha = \frac{\beta}{\beta + 1} \Longleftrightarrow \beta = \frac{\alpha}{1 - \alpha}$$

- (e) In most cases, $V_A\gg V_{CE}$ so the factor is approximately 1
- (f) Model:

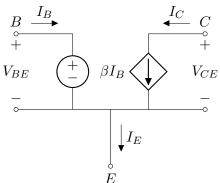


Figure 11: NPN Transistor Active Mode

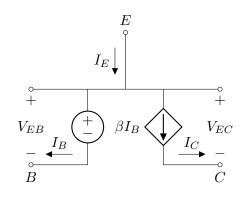


Figure 12: PNP Transistor Active Mode

3. Saturation Mode Relationships

- (a) $I_{C, sat} = \beta_{forced} I_B$
- (b) $V_{BE} = 0.7 V$, $V_{EB} = 0.7 V$
- (c) $V_{CE}=0.3~V$, $V_{EC}=0.3~V$ edge of saturation
- (d) deep saturation is normally 0.2 V

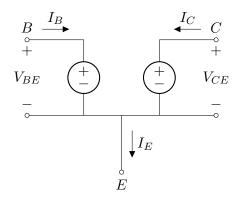


Figure 13: NPN Transistor Saturation Mode

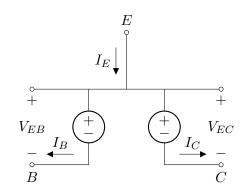


Figure 14: PNP Transistor Saturation

3.2 BJT Biasing Circuits

- 1. Q point: fixed characteristics of the transistor
 - (a) active region for amplifier
 - (b) cut-off/saturation for switches
- 2. Biasing: application of DC voltages to establish the operating point
- 3. Transistor Parameter variations on Temperature:
 - (a) leakage current: $I_{Co}(25^{\circ}C) = 1 \ nA$. doubles every 6° rise
 - (b) $V_{BE}(25^{\circ}C)=0.7~V.$ drops about $2.2~mV/^{\circ}C$
 - (c) β doubles with an increase of $80^{\circ}C$

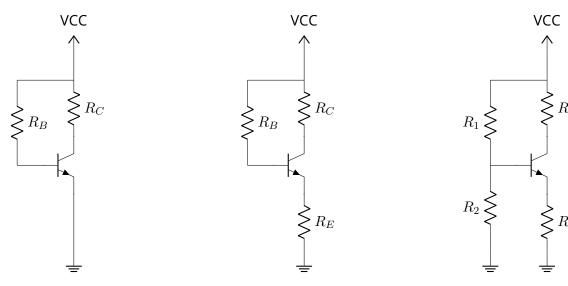


Figure 15: Fixed Bias Circuit

Figure 16: Emitter Stabilized

Figure 17: Voltage Divier Bias

3.3 BJT Amplifiers

- 1. General steps in circuit analysis:
 - (a) In the DC part, treat the capacitors as open
 - (b) The DC analysis calculates the Q point values
 - (c) In the AC part, treat the capacitors and DC voltage sources as shorts
- 2. Common Emitter Amplifier:
 - (a) Inverting amplifier with very huge gains

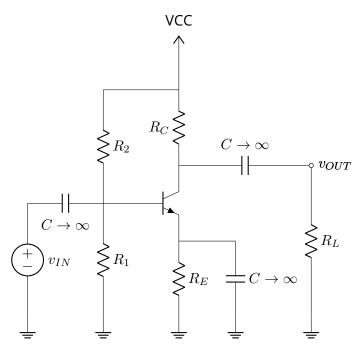
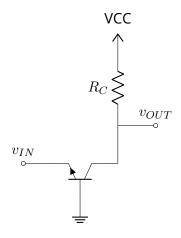
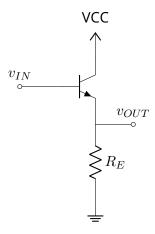


Figure 18: CE Amplifier

- 3. Common Base Amplifier:
 - (a) has a sudden rise of gain in the vicinity of the V_{BE} threshold



- 4. Common Collector Amplifier:
 - (a) has unity gain
 - (b) is a voltage follower



4 MOSFETs as Amplifiers

4.1 MOSFET Fundamentals

- 1. FET: an electric field is applied normal to the surface (gate) of a semiconductor that modulates the conductance of the semiconductor
 - (a) NMOS: uses electrons as charge carriers
 - (b) PMOS: uses holes as charge carriers
- 2. The source and drain terminals are heavily doped (n for NMOS, p for PMOS)
 - (a) Enhancement Mode: default off
 - (b) Depletion Mode: default on
- 3. Threshold voltage: minimum V_{GS} for the MOSFET to conduct
- 4. Saturation Voltage: minimum V_{DS} that causes the channel of the transistor to pinch-off in the drain side due to widening depletion region in the drain bulk junction
- 5. MOSFET Regions of Operation:

Region of Operation	Conditions (NMOS)	Current I_D	
Cut-off	$V_{GS} < V_{Th, n}$	$I_D = 0$	
Linear	$V_{GS} \ge V_{Th, n}$	$I_D = k_n \left(V_{GS} - V_{Th, n} - \frac{V_{DS}}{2} \right) V_{DS}$	
Linear	$V_{DS} < V_{GS} - V_{Th, n}$		
Saturation	$V_{GS} \ge V_{Th, n}$	$I_D = \frac{1}{2} k_n \left(V_{GS} - V_{Th, n} \right)^2$	
Saturation	$V_{DS} \ge V_{GS} - V_{Th, n}$		
Region of Operation	Conditions (PMOS)	Current I_D	
Cut-off	$V_{GS} < V_{Th, n}$	$I_D = 0$	
Linear	$V_{SG} \ge V_{Th, p} $	$I_D = -k_p \left(V_{SG} - V_{Th, p} - \frac{V_{SD}}{2} \right) V_{SD}$	
Linear	$V_{SD} < V_{SG} - V_{Th, p}$	$TD = -\kappa_p \left(VSG - VTh, p - \frac{1}{2} \right) VSD$	
Saturation	$V_{SG} \ge V_{Th, p}$	$I_D = -\frac{1}{2} k_p \left(V_{SG} - V_{Th, p} \right)^2$	
Sacaration		$ID = -\frac{1}{2}\kappa_p (VSG - VTh, p)$	

4.2 MOSFET DC Characterization

- 1. Steps in solving MOSFET circuits:
 - (a) Identify the terminals
 - (b) Solve for voltage terminals
 - (c) Use the current equation to ge I_D . assume saturation if region of operation is unknown

4.3 MOSFET Amplifier

- 1. Common Source Amplifier:
 - (a) inverting amplifier
 - (b) can have large gains

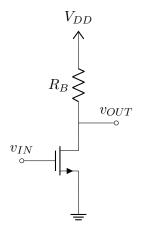


Figure 19: NMOS CS Amplifier

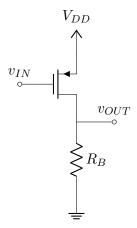


Figure 20: PMOS CS Amplifier

- 2. Common Drain Amplifier:
 - (a) has a unity gain
 - (b) non-inverting amplifier

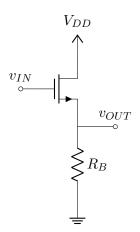


Figure 21: NMOS CD Amplifier

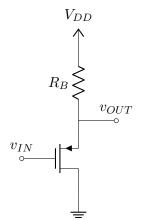


Figure 22: PMOS CD Amplifier

3. Common Gate Amplifier:

- (a) non-inverting amplifier
- (b) can have gain more than 1

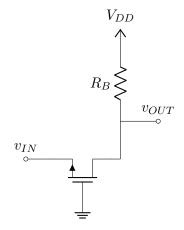


Figure 23: NMOS CG Amplifier

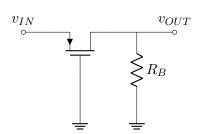


Figure 24: PMOS CG Amplifier

5 Small Signal Analysis of Transistor Amplifiers

5.1 Two Port Networks

- 1. one port serves as input, the other as output
- 2. Z parameters: impedance parameters. taken for open circuit of both ports

$$\begin{bmatrix} V_1 \\ V_2 \end{bmatrix} = \begin{bmatrix} Z_{1, \ 1} & Z_{1, \ 2} \\ Z_{2, \ 1} & Z_{2, \ 2} \end{bmatrix} \begin{bmatrix} I_1 \\ I_2 \end{bmatrix}$$

3. Y parameters: admittance parameters. taken for short circuit of both ports

$$\begin{bmatrix} I_1 \\ I_2 \end{bmatrix} = \begin{bmatrix} Y_{1, 1} & Y_{1, 2} \\ Y_{2, 1} & Y_{2, 2} \end{bmatrix} \begin{bmatrix} V_1 \\ V_2 \end{bmatrix}$$

4. h parameters: hybrid parameters. first column is short circuit of Port 2, second column is open circuit for Port 1

$$\begin{bmatrix} V_1 \\ I_2 \end{bmatrix} = \begin{bmatrix} h_{1, 1} & h_{1, 2} \\ h_{2, 1} & h_{2, 2} \end{bmatrix} \begin{bmatrix} I_1 \\ V_2 \end{bmatrix}$$

5. g parameters: inverse hybrid parameters. tfirst column is open circuit of Port 2, second column is short circuit for Port 1

$$\begin{bmatrix} I_1 \\ V_2 \end{bmatrix} = \begin{bmatrix} g_{1, 1} & g_{1, 2} \\ g_{2, 1} & g_{2, 2} \end{bmatrix} \begin{bmatrix} V_1 \\ I_2 \end{bmatrix}$$

- 6. Unilateral Hybrid π Network: only has 3 parameters
 - (a) R_i , R_o , A_v for Thevenin Equivalent
 - (b) R_i , R_o , G_m for Norton Equivalent

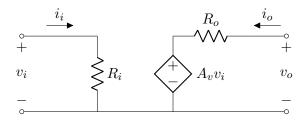


Figure 25: Thevenin Equivalent

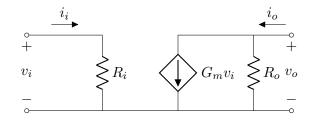


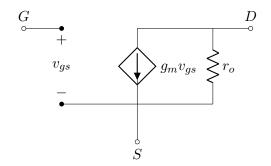
Figure 26: Norton Equivalent

Figure 27: Unilateral Hybrid π Network

5.2 Small Signal Model

Parameter	ВЈТ	MOSFET
g_m Transconductance	$g_m = \frac{I_C}{V_T}$	$g_m = \frac{2I_D}{V_{GS} - V_{Th, n}} = \sqrt{2K_n I_D (1 + \lambda V_{DS})} \approx \sqrt{2K_n I_D}$
r_{π} Input Resistance	$r_{\pi} = \frac{\beta}{g_m} = \frac{\beta V_T}{I_C}$	$r_{\pi} = \infty$
r_o Output Resistance	$r_o = \frac{V_A + V_{CE}}{I_C} \approx \frac{V_A}{I_C}$	$\left \frac{1}{I_D} \left(\frac{1}{\lambda} + V_{DS} \right) pprox \frac{1}{\lambda I_D} \right $

- 1. the approximations above are from:
 - (a) $V_A\gg V_{CE}$
 - (b) $\lambda \ll \frac{1}{V_{DS}}$



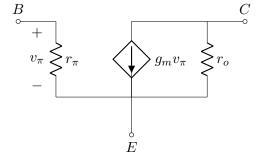


Figure 28: MOSFET Small Signal Model

Figure 29: BJT Small Signal Model

5.3 Small Signal Analysis

1. Amplifier Parameters:

Voltage Gain	$A_v = \frac{v_o}{v_i}$
Open-loop Gain	$A_{vo} = \frac{v_o}{v_i} \Big _{R_L \to \infty}$
Input Resistance	$R_i = \frac{v_i}{i_i} \Big _{i_{out} = 0}$
Output Resistance of Amplifier	$\left R_o = \frac{v_o}{i_o} \right _{v_{in} = 0}$
Output Resistance of the circuit	$R_{out} = \frac{v_o}{i_o} \Big _{v_{sig} = 0}$
Equivalent Transistor Gain	$G_m = \frac{i_o}{v_i}\Big _{v_o = 0}$
Overall Gain	$A = \frac{R_i}{R_i + R_{sig}} A_v$

- 2. Design considerations:
 - (a) $R_i \gg R_{sig}$
 - (b) $R_o \ll R_L$
- 3. Solving Amplifier Circuits
 - (a) Find Bias and Signal Circuits
 - (b) Get the bias (Q point) values
 - i. capacitors are open
 - ii. large signal models
 - (c) Get the signal paramaters
 - i. capacitors are shorts
 - ii. independent sources are suppressed
 - iii. replace with small signal model
 - (d) Terminal Resistance:
 - i. Consider that a voltage v_x and current i_x is supplied through the terminal. the terminal resistance is $\frac{v_x}{i_x}$

6 Amplifier Frequency Response

6.1 Introduction to Frequency Response

1. Transfer function:

$$A_{v}(\omega) = \frac{v_{o}(\omega)}{v_{i}(\omega)}$$

$$|A_{v}| = \sqrt{\Re e (A_{v})^{2} + \Im m (A_{v})^{2}}$$

$$\angle A_{v} = \tan^{-1} \left(\frac{\Im m (A_{v})}{\Re e (A_{v})}\right)$$

- 2. In phasor analysis: $|v_o| \exp(j \angle v_o) = |A_v| |v_i| \exp(j (\angle A_v + \angle v_o))$
 - (a) the -3 dB happens at ω_0
 - (b) power $P_v\left(\omega_0\right)=rac{1}{2}$
- 3. Bode Plots: approximate plots for the magnitude and phase of the transfer function

	I	
Term	Magnitude	Phase
Constant	$20\log_{10} K $	$K > 0:0^{\circ}$
		$K < 0: \pm 180^{\circ}$
Real Pole	$\omega < \omega_0 : 0$ dB/dec slope	$0.1\omega_0:0^{\circ}$
	$\omega \geq \omega_0: -20$ dB/dec slope	$10\omega_0:-90^\circ$
Real Zero	$\omega < \omega_0 : 0$ dB/dec slope	$0.1\omega_0:0^{\circ}$
	$\omega \geq \omega_0: +20$ dB/dec slope	$10\omega_0:+90^{\circ}$
Pole at Origin	-20 dB/dec slope at $(1,0)$	-90°
Zero at Origin	+20 dB/dec slope at $(1,0)$	+90°

- (a) a pole/zero repeated n times multiplies the slopes and $\mp 90^{\circ}$ by n
- (b) if $\omega_0 < 0$, change the signs of the phase (pole/zero) but not the magnitude

6.2 Transistor Capacitances

1. BJT Parasitic Capacitances

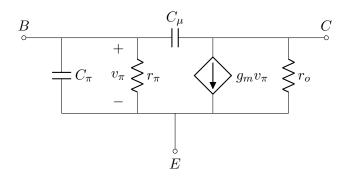


Figure 30: BJT Small Signal Model with Parasitic Capacitances

- (a) $C_{\pi} = C_b + C_{je}$
- (b) BCJ Capacitance (5 10 fF): $C_{\mu} = \frac{C_{\mu0}}{\sqrt{1+\frac{V_{CB}}{V_{j,~CB}}}}$
 - i. Miller Effect when Common Emitter
- (c) Base-Charging Capacitance (100s fF): $C_b = \tau_F g_m = \tau_F \frac{I_C}{V_T}$
 - i. forward base transit time au_F : average time per carrier spent crossing the base

(d) BEJ Capacitance (10s of fF):
$$C_{je}=\frac{C_{je0}}{\sqrt{1+\frac{V_{BE}}{V_{j,~BE}}}} \approx 2C_{je0}$$

2. MOSFET Parasitic Capacitances:

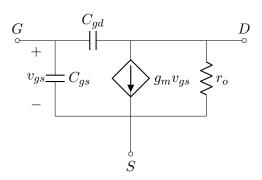


Figure 31: MOSFET Small Signal Model

- (a) GS Capacitance (Parallel Plate + Gate Overlap): C_{gs}
 - i. largest parasitic in MOSFET
- (b) GD Capacitace (Gate Overlap only)
 - i. Miller Effect when Common Source
- (c) Source/Drain Junction: normally reverse biased and omitted in the small signal model

6.3 Transition Frequency

- 1. Transition frequency : frequency where $\frac{i_o}{i_i}=1$ (short circuit output gain). if $i_o < i_i$, the transistor is not working as an amplifier that that frequency
- 2. at $\omega=0$, the BJT current gain is β
- 3. the BJT current transfer function: $\frac{i_o\left(s\right)}{i_i\left(s\right)} = \frac{g_m sC_\mu}{1/r_\pi + s\left(C_\pi + C_\mu\right)} = g_m r_\pi \frac{1 s\left(\frac{C_\mu}{g_m}\right)}{1 + s\left(r_\pi\left(C_\mu + C_\pi\right)\right)}$
 - (a) $\omega_z = -rac{g_m}{C_\mu}$
 - (b) $\omega_p = \frac{1}{r_\pi \left(C_\mu + C_\pi \right)}$
- 4. the BJT transition frequency is $f_T=rac{\omega_T}{2\pi}=rac{1}{2\pi}\sqrt{rac{g_m^2-\left(rac{1}{r_\pi}
 ight)^2}{\left(C_\pi+C_\mu
 ight)^2-C_\mu^2}}pproxrac{1}{2\pi}rac{g_m}{C_\pi-C_\mu}$
- 5. at $\omega = 0$, the MOSFTET current gain is $+\infty$
- 6. the MOSFET current transfer function: $\frac{i_o}{i_i} = \frac{g_m sC_{gd}}{s\left(C_{gd} + C_{gs}\right)} = \frac{1 s\left(\frac{C_{gd}}{g_m}\right)}{s\left(\frac{C_{gd} + C_{gs}}{g_m}\right)}$
 - (a) $\omega_z = -rac{g_m}{C_{gd}}$
 - (b) $\omega_p = \frac{g_m}{C_{qd} + C_{qs}}$
- 7. the MOSFET transition frequency is $f_T=rac{\omega_T}{2\pi}=rac{1}{2\pi}rac{g_m}{\sqrt{\left(C_{gd}+C_{gs}
 ight)^2-C_{gd}^2}}pprox rac{1}{2\pi}rac{g_m}{C_{gd}+C_{gs}}$

6.4 Frequency Response of CE Amplifier

- $1. A_v = \frac{v_o}{v_i} \bigg|_{i_o = 0}$
- $2. G_m = \frac{i_o}{v_i} \bigg|_{v_o = 0}$
- 3. $Z_i = \frac{v_i}{i_i}\bigg|_{v_i=0}$
- $4. Z_o = \frac{v_o}{i_o} \bigg|_{v_i = 0}$
- 5. Single Pole CE Amplifier:
 - (a) $A_v = \left(-g_m R_C\right) \frac{1}{1 + s \left(R_C C_L\right)}$
 - (b) $Z_i = r_{\pi}$
 - (c) $Z_o = \frac{R_C}{1 + s \left(R_C C_L\right)}$

6. Considering the input resistance and input capacitance

(a)
$$A_v = \left(-g_m R_C \frac{r_\pi}{r_\pi + R_S}\right) \frac{1}{\left(1 + s\left(\frac{R_S r_\pi C_\pi}{R_S + r_\pi}\right)\right)}$$

(b)
$$Z_i=(R_s+r_\pi)\,rac{1+s\left(rac{R_sr_\pi C_\pi}{R_s+r_\pi}
ight)}{1+s\left(r_\pi C_\pi
ight)}$$

(c)
$$Z_o = (R_C) \frac{1}{1 + s (R_C C_L)}$$

7. Considering the input resistance and Miller capacitance

(a)
$$A_v \approx \left(-g_m R_C \frac{r_{\pi}}{r_{\pi} + R_S}\right) \frac{1 - s\left(\frac{C_{\mu}}{g_m}\right)}{\left[1 + s\left(R\left[C_L + C_{\mu}\right]\right)\right] \left[1 + s\left(\frac{R_s r_{\pi} C_{\mu}(1 + g_m R_C)}{R_s + r_{\pi}}\right)\right]}$$

6.5 Gain Bandwidth Product

1. Single Pole Amplifier:
$$A\left(\omega\right)=\frac{A_{o}}{1+j\frac{\omega}{\omega_{p}}}$$

(a)
$$\omega_u = \omega_p \sqrt{A_o^2 - 1} \approx A_o \omega_p$$

(b) for all
$$\omega_x \in [\omega_p, \ \omega_u] \,, \ A_x \omega_x = A_o \omega_p = GBP$$

2. Two Pole Amplifer:
$$A\left(\omega\right)=\dfrac{A_{o}}{\left[1+j\frac{\omega}{\omega_{p1}}\right]\left[1+j\frac{\omega}{\omega_{p2}}\right]}$$

(a) case 1:
$$\omega_u > \omega_{p2}: \omega_u = A_o \omega_{p1}$$

(b) case 2:
$$\omega_u < \omega_{p2}$$
 : $\omega_u = \sqrt{A_o \omega_{p1} \omega_{p2}}$